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6A, 100V - 200V Ultra Fast Surface Mount Rectifier

FEATURES

- AEC-Q101 qualified
- Planar technology
- Low power loss, high efficiency
- Ideal for automated placement
- Wettable flank
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

APPLICATIONS

- High frequency switching
- DC/DC
- Snubber

MECHANICAL DATA

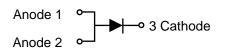
- Case: TO-277A (SMPC4.6U)
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: Indicated by cathode band
- Weight: 0.104g (approximately)

KEY PARAMETERS			
VALUE	UNIT		
6	А		
100 - 200	V		
200	А		
175	°C		
TO-277A (SMPC4.6U)			
Single die			
	VALUE 6 100 - 200 200 175 TO-27 (SMPC4		

HALOGEN



TO-277A (SMPC4.6U)



ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted)					
PARAMETER		SYMBOL	PUUP6BH	PUUP6DH	UNIT
Marking code on the device			PU6BH	PU6DH	
Repetitive peak reverse voltage		V _{RRM}	100	200	V
Reverse voltage, total rms value		V _{R(RMS)}	70	140	V
Forward current		١ _F	6		А
Surge peak forward current single half	t = 8.3ms		2		A
sine-wave superimposed on rated load	t = 1.0ms	IFSM	410		
Junction temperature		TJ	-55 to +175		°C
Storage temperature		T _{STG}	-55 to +175		°C



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THERMAL PERFORMANCE			
PARAMETER	SYMBOL	ТҮР	UNIT
Junction-to-lead thermal resistance ⁽¹⁾	R _{ƏJL}	2.0	°C/W
Junction-to-ambient thermal resistance ⁽²⁾	R _{ØJA}	48.7	°C/W
Junction-to-case thermal resistance ⁽²⁾	R _{eJC}	9.0	°C/W

Thermal Performance Notes:

1. With ideal heat sink

2. Units mounted on PCB (16mm x 16mm Cu pad test board)

PARAMETER	CONDITIONS	SYMBOL	ТҮР	MAX	UNIT
Forward voltage ⁽¹⁾	$I_F = 3A, T_J = 25^{\circ}C$		0.79	-	V
	$I_F = 6A, T_J = 25^{\circ}C$	N	0.85	0.94	V
	$I_F = 3A, T_J = 125^{\circ}C$	V _F	0.65	-	V
	$I_F = 6A, T_J = 125^{\circ}C$		0.71	-	V
Reverse current @ rated $V_R^{(2)}$	$T_J = 25^{\circ}C$	I _R	-	2	μA
	T _J = 125°C		-	15	μA
Junction capacitance	1MHz, V _R = 4.0V	CJ	96	-	pF
Reverse recovery time	$I_F = 0.5A, I_R = 1.0A, I_{rr} = 0.25A$		-	25	ns
	$I_F = 1.0A, di/dt = 50A/\mu s, V_R = 30V$	t _{rr}	31	-	
Reverse recovery current		I _{RM}	5.3	-	Α
Reverse recovery charge	$I_F = 6.0A$, di/dt = 200A/µs, $V_R = 100V$	Q _{rr}	72	-	nC
Reverse recovery time		t _{rr}	27	-	ns

Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

ORDERING INFORMATION

ORDERING CODE ⁽¹⁾	PACKAGE	PACKING
PUUP6xH	TO-277A (SMPC4.6U)	6,000/ Tape & Reel

Notes:

1. "x" defines voltage from 100V(PUUP6BH) to 200V(PUUP6DH)



f=1.0MHz

Vsig=50mVp-p

100

CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

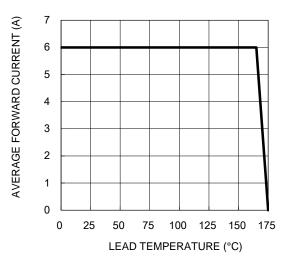
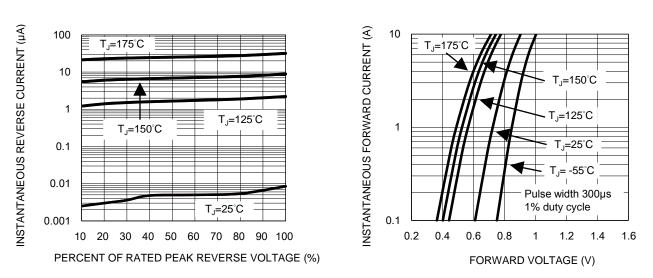


Fig.1 Forward Current Derating Curve

Fig.3 Typical Reverse Characteristics



1000

100

10

1

CAPACITANCE (pF)

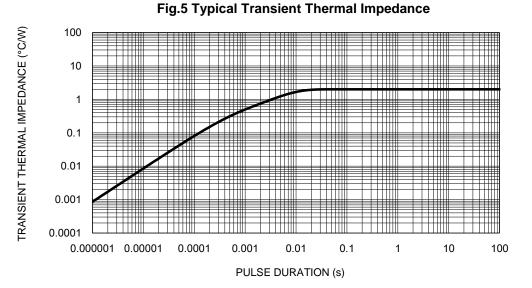


Fig.2 Typical Junction Capacitance

10

Fig.4 Typical Forward Characteristics

REVERSE VOLTAGE (V)

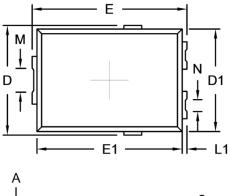
PUUP6BH – PUUP6DH

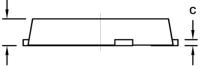
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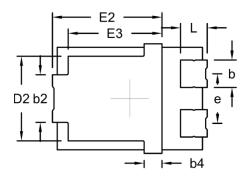


PACKAGE OUTLINE DIMENSIONS

TO-277A (SMPC4.6U)







SUGGESTED PAD LAYOUT

В

D

F

1

С

1

DIM.	Unit (mm)		Unit ((inch)
	Min.	Max.	Min.	Max.
A	1.00	1.20	0.039	0.047
b	1.05	1.35	0.041	0.053
b2	1.90	2.20	0.075	0.087
b4	0.75 (NOM.)	0.030	(NOM.)
с	0.15	0.40	0.006	0.016
D	4.45	4.75	0.175	0.187
D1	4.25	4.35	0.167	0.171
D2	3.40	3.70	0.134	0.146
E	6.35	6.65	0.250	0.262
E1	6.05	6.15	0.238	0.242
E2	4.40	4.80	0.173	0.189
E3	3.94 (NOM.)		0.155	(NOM.)
е	2.08 (NOM.)		0.082	(NOM.)
L	0.94	1.24	0.037	0.049
L1	0.05	0.35	0.002	0.014
М	0.65	1.15	0.026	0.045
N	0.25	0.75	0.010	0.030

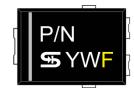
Package body size D1 and E1 do not include mold flash Mold flash shall not exceed 0.1mm per side

Symbol	Unit (mm)	Unit (inch)
A	4.95	0.195
В	4.95	0.195
С	1.60	0.063
D	1.42	0.056
E	6.95	0.274
F	1.04	0.041

MARKING DIAGRAM

A

1



– E -

P/N	= Marking Code
YW	= Date Code
F	= Factory Code



PUUP6BH – PUUP6DH

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